

General Purpose Epoxy

Key Feature

Adheres to Dissimilar Materials
High Temperature Resistant
Low Shrinkage
Non-free Flowing
Room Temperature Cure
Withstands Reflow

Uncured

Pot Life (hrs)	> 2	
Viscosity (cps)	10,000	@ 25° C and 20 (sec) ⁻¹
Work Life (hrs)	> 2	

Recommended Cure

2 hrs. @ 65° C

Other Cure

1 day @ 25° C

Cured

% Shrinkage by Volume	0.03	1 day @ 25° C
Color	Black	
Lap Shear 2024T3 Clad FPL Etch (psi)	4,100	
Shore Hardness	D/83/0	
Slump (in)	0.0	

Electrical

Dielectric Constant	3.6	1K Hz
Dissipation Factor	0.009	1K Hz
Volume Resistivity (ohm*cm)	1.0E + 14	

Thermal

Degradation Temp (°C)	300
Glass Transition Temp (°C)	50

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7 Industrial Way, Unit 1, Salem, NH 03079 / Phone: 603-685-0500 / Fax: 603-685-0236 / Web: www.appli-tec.com